

Click [here](#) for the 3D model.

### Dimensions

D	116mm +2mm
L	233mm +/-2mm
L1	236mm +/-2mm
S	50mm +/-0.3mm
D1	119mm +0.5mm

### Packaging Specifications

Mounting	Through-Hole
Terminal Type	Bolt - M12x16
Packaging	Bulk, Bag
Packaging Quantity	4

### General Information

Series	C44U-M
Dielectric	Metallized Polypropylene
Style	Can
Features	DC Filtering, Energy Storage
RoHS	With Exemptions
REACH	SVHC (Pb - CAS 7439-92-1)
SCIP Number	cc1c1ec4-db9e-4815-b26b-e8a34ddfb776
Lead	Screw Terminals M6
AEC-Q200	No
Typical Component Weight	2850 g
Miscellaneous	Thermal Resistance = 2.1 C/W. Weight = 11500 grams.

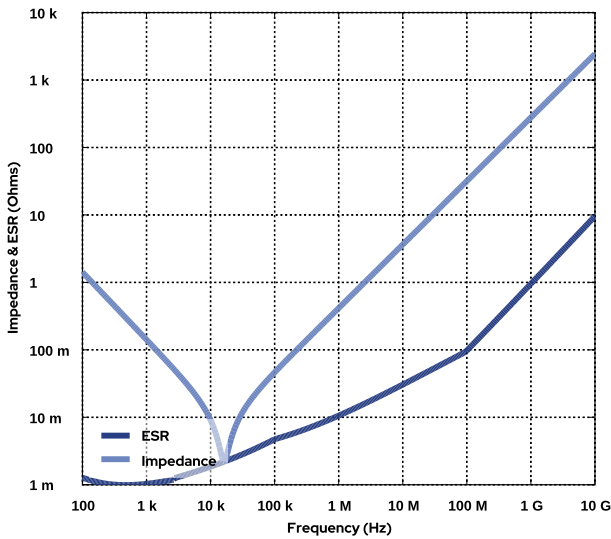
### Specifications

Capacitance	1100 uF
Capacitance Tolerance	10%
Voltage DC	1100 VDC
Temperature Range	-40/+85°C
Rated Temperature	75°C
Insulation Resistance	30 MOhms
Max dV/dt	9 V/us
ESR	1.4 mOhms (10kHz)
Ripple Current	100 Amps (10kHz 40C), 9750 Amps (Peak)
Inductance	75 nH

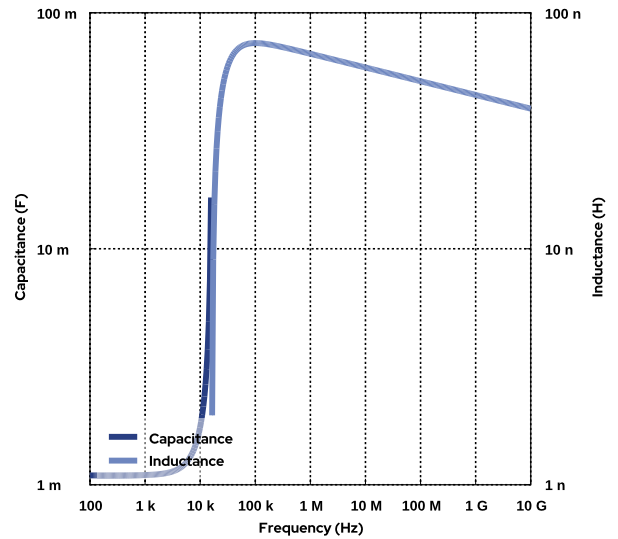
## Simulations

For the complete simulation environment please visit [K-SIM](#).

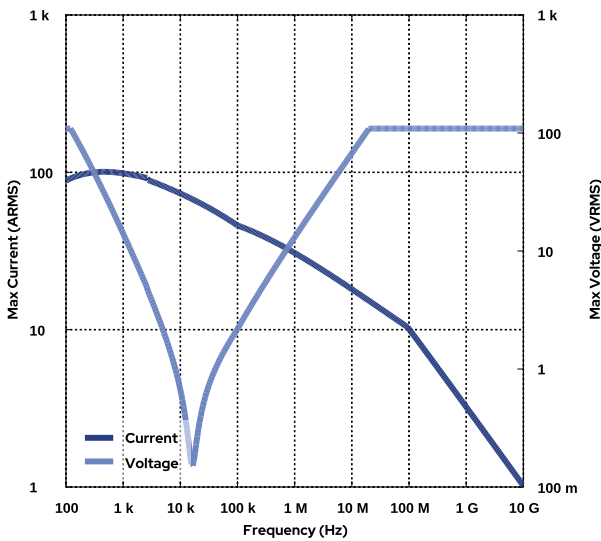
**Impedance and ESR**



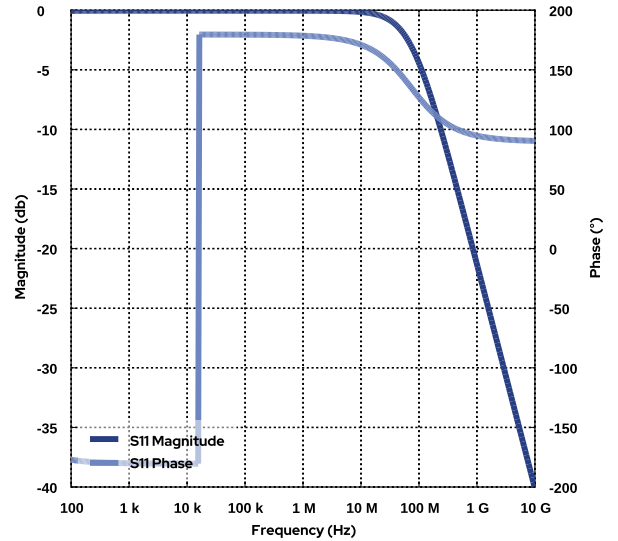
**Capacitance and Inductance**

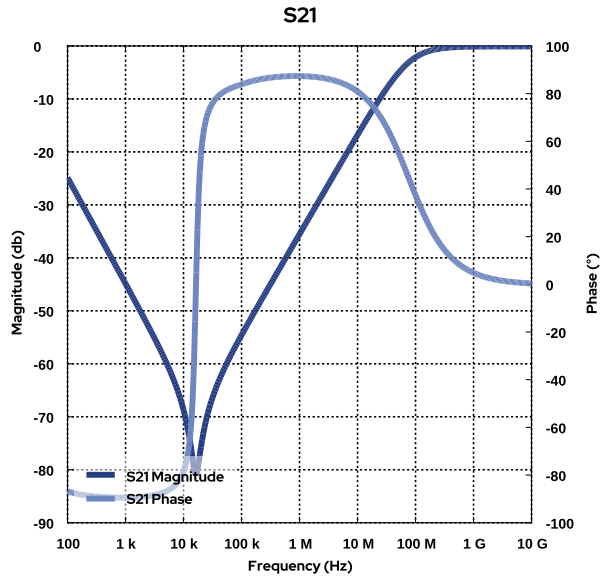


**Current and Voltage**



**S11**





**These are simulations.**

This is not a specification!

The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

The responses shown do not represent a specified or implied maximum capability of the device for all applications.

- The ESR used for ripple "Ripple Current/Voltage vs. Frequency" plots is the ESR at ambient temperature.
- The ESR in the "Temperature Rise vs. Ripple Current" plots is adjusted to each incremental temperature rise before the power and ripple current is calculated.
- The effects shown herein are based on measured data from a multiple part sample of the parts in question.
- Ripple capability of this device will be factored by thermal resistance (Rth) created by circuit traces (addi affects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance).
- The peak voltages generated in the "Temperature Rise vs. Combined Ripple Currents" plot are calculated for each frequency and are not combined with voltages generated at any other harmonics.
- Please consult with the catalog or field applications engineer for maximum capability of the device in specific applications.

All product information and data (collectively, the "Information") are subject to change without notice.

KEMET K-SIM is designed to simulate behavior of components with respect to frequency, ambient temperature, and DC bias levels. The responses shown represent the typical response for each part type. Specific responses may vary, depending on manufacturing variation effects of all parameters involved, including the specified tolerances applied to capacitance and unspecified variations of ESR, ESL, and leakage resistance.

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If you have any questions please contact K-SIM.